L	Hits	Search Text	DB	Time stamp
Number				
1	0	photdiode near2 array and substrate and	USPAT;	2004/08/25
		terminal and first near pad and second	EPO; JPO;	16:27
		near pad and wire	DERWENT	
2	2	photodiode near2 array and substrate and	USPAT;	2004/08/25
1		terminal and first near pad and second	EPO; JPO;	16:38
		near pad and wire	DERWENT	1
3	9	photodiode and substrate and terminal and	USPAT;	2004/08/25
l i		first near pad and second near pad and	EPO; JPO;	16:39
		wire	DERWENT	
4	7	(photodiode and substrate and terminal	USPAT;	2004/08/25
		and first near pad and second near pad	EPO; JPO;	16:39
]		and wire) not (photodiode near2 array and	DERWENT	!
		substrate and terminal and first near pad		
•		and second near pad and wire)		

L	Hits	Search Text	DB	Time stamp
Number				
1	0	photdiode near2 array and substrate and	USPAT;	2004/08/25
		terminal and first near pad and second	EPO; JPO;	16:27
1		near pad and wire	DERWENT	
2	2	photodiode near2 array and substrate and	USPAT;	2004/08/25
		terminal and first near pad and second	EPO; JPO;	16:38
		near pad and wire	DERWENT	
3	9	photodiode and substrate and terminal and	USPAT;	2004/08/25
		first near pad and second near pad and	EPO; JPO;	16:39
		wire	DERWENT	
4	7	(photodiode and substrate and terminal	USPAT;	2004/08/25
		and first near pad and second near pad	EPO; JPO;	16:53
		and wire) not (photodiode near2 array and	DERWENT	
		substrate and terminal and first near pad		
		and second near pad and wire)		
5	642	pad near5 (formation or protrusion) and	USPAT;	2004/08/25
		wire and pad and substrate	EPO; JPO;	16:54
			DERWENT	
6	85	pad near5 (formation or protrusion) near5	USPAT;	2004/08/25
j		section	EPO; JPO;	16:54
			DERWENT	
8	0	(pad near5 (formation or protrusion)	USPAT;	2004/08/25
İ		near5 section) and (photodiode and first	EPO; JPO;	16:55
		adj pad and second adj pad)	DERWENT	
7	15	photodiode and first adj pad and second	USPAT;	2004/08/25
		adj pad	EPO; JPO;	16:55
			DERWENT	

L	Hits	Search Text	DB	Time stamp
Number				_
4	0	(mis and mid) adj substrate	USPAT;	2004/08/25
1			EPO; JPO;	10:59
}			DERWENT	
5	44	(mis or mid) adj substrate	USPAT;	2004/08/25
ì			EPO; JPO;	11:00
į.			DERWENT	
8	0	(mis adj substrate) and (mid adj	USPAT;	2004/08/25
1		substrate)	EPO; JPO;	11:00
			DERWENT	
9	0	(mis adj substrate) and photo and light	USPAT;	2004/08/25
		and pad and bond\$3 adj2 wir\$3	EPO; JPO;	11:01
			DERWENT	
10	0	(mid adj substrate) and photo and light	USPAT;	2004/08/25 .
		and pad and bond\$3 adj2 wir\$3	EPO; JPO;	11:01
			DERWENT	
11	0	(mid adj substrate) and light and pad and	USPAT;	2004/08/25
		bond\$3 adj2 wir\$3	EPO; JPO;	11:02
			DERWENT	
13	0	(mis adj substrate) and light and pad and	USPAT;	2004/08/25
		bond\$3 near2 wir\$3	EPO; JPO;	11:02
			DERWENT	
12	1	(mid adj substrate) and light and pad and	USPAT;	2004/08/25
1		bond\$3 near2 wir\$3	EPO; JPO;	11:02
			DERWENT	_
6	6	mis adj substrate	USPAT;	2004/08/25
1			EPO; JPO;	11:03
j			DERWENT	
7	38	mid adj substrate	USPAT;	2004/08/25
1			EPO; JPO;	11:03
			DERWENT	

L	Hits	Search Text	DB	Time stamp
Number				
1	1992	light adj emitting adj diode and pad\$1	USPAT;	2004/08/25
		and substrate	EPO; JPO;	17:25
			DERWENT	
2	0	phot adj diode and pad\$1 and substrate	USPAT;	2004/08/25 .
			EPO; JPO;	17:25
			DERWENT	
3	422	photo adj diode and pad\$1 and substrate	USPAT;	2004/08/25
			EPO; JPO;	17:25
			DERWENT	
4	422	(photo adj diode and pad\$1 and substrate	USPAT;	2004/08/25
) and substrate	EPO; JPO;	17:25
			DERWENT	
5	18	(photo adj diode and pad\$1 and substrate	USPAT;	2004/08/25
) and substrate near5 (protrusion or	EPO; JPO;	17:26
		recess)	DERWENT	